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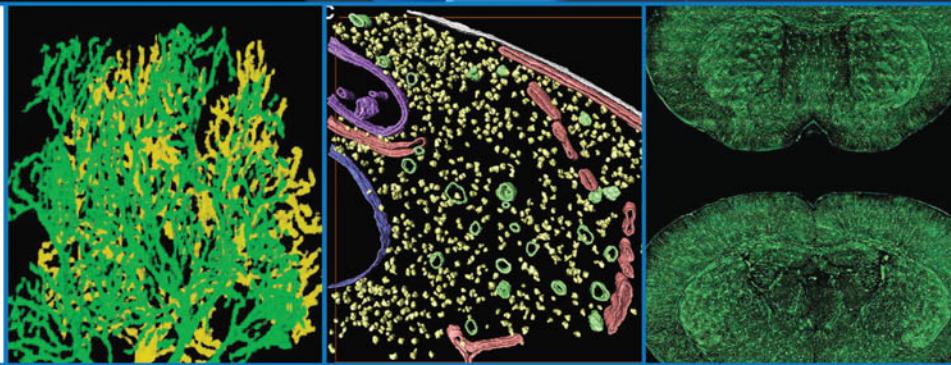


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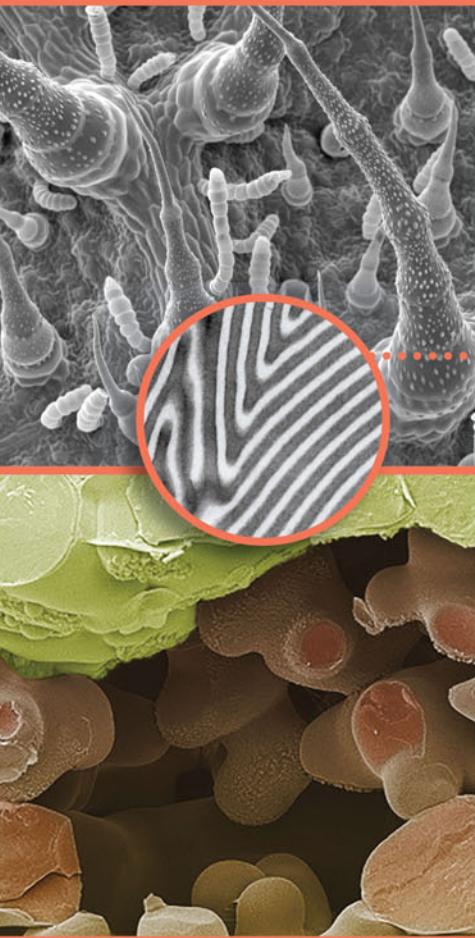
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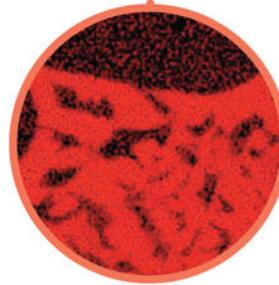
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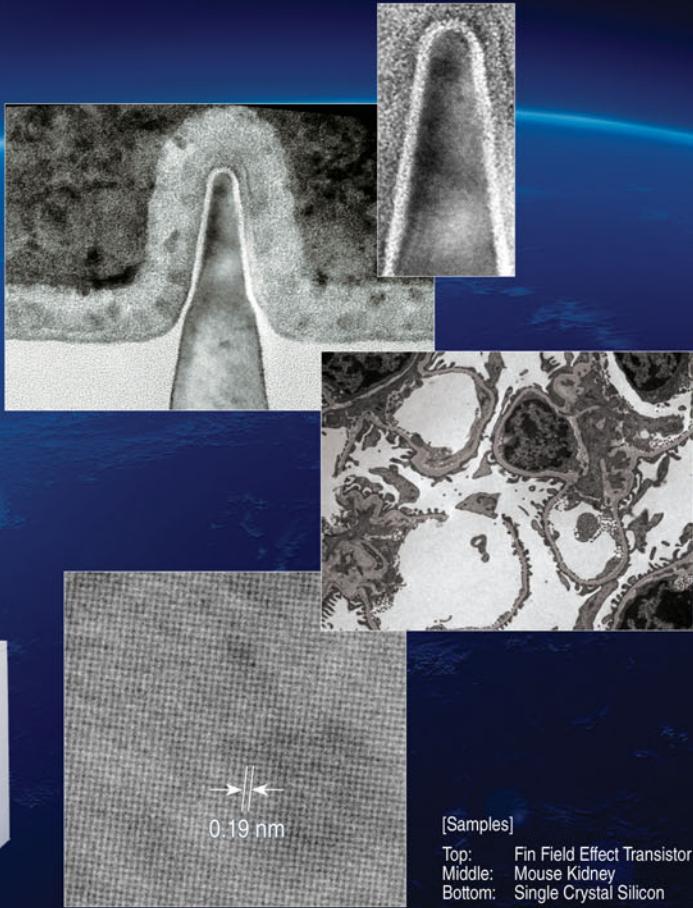
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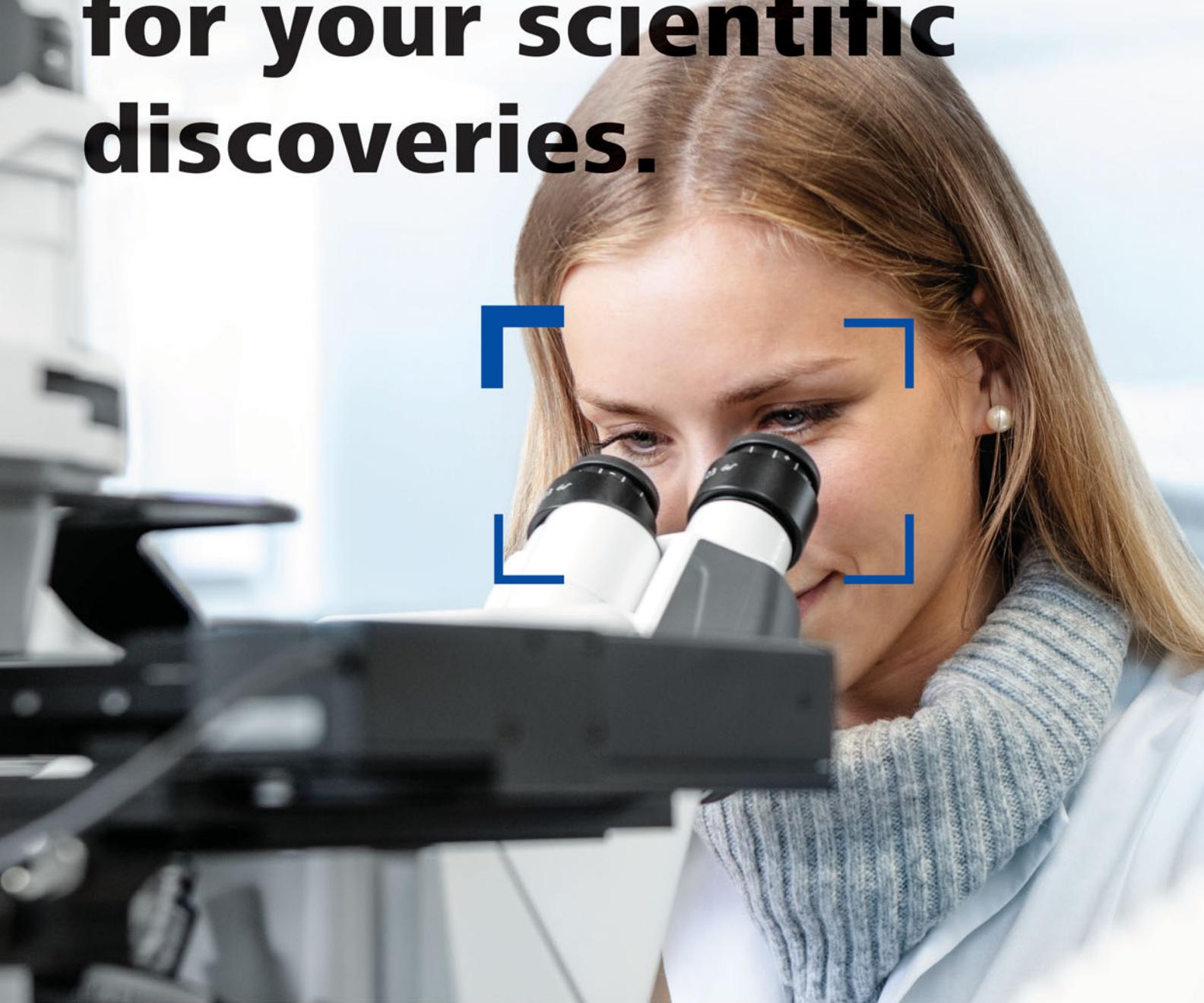


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1. Publication Title <b>MICROSCOPY AND MICROANALYSIS</b>	2. Publication Number <b>021 - 917</b>	3. Filing Date <b>10/1/2019</b>
4. Issue Frequency <b>FEBRUARY, APRIL, JUNE, AUGUST, OCTOBER, DECEMBER</b>	5. Number of Issues Published Annually <b>6</b>	6. Annual Subscription Price <b>\$2364</b>

7. Complete Mailing Address of Known Office of Publication (*Not printer*) (Street, city, county, state, and ZIP+4<sup>®</sup>)  
**Cambridge University Press  
1 Liberty Plaza  
New York, NY 10006**

Contact Person  
**Nina Iammateo**  
Telephone (Include area code)  
**2123345000**

8. Complete Mailing Address of Headquarters or General Business Office of Publisher (*Not printer*)  
**Cambridge University Press  
University Printing House, Shaftesbury Road  
Cambridge CB2 8BS**

9. Full Names and Complete Mailing Addresses of Publisher, Editor, and Managing Editor (*Do not leave blank*)  
**Publisher (Name and complete mailing address)  
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<b>MICROSCOPY AND MICROANALYSIS</b>	<b>AUGUST 2019</b>

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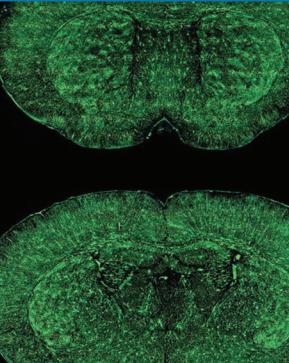
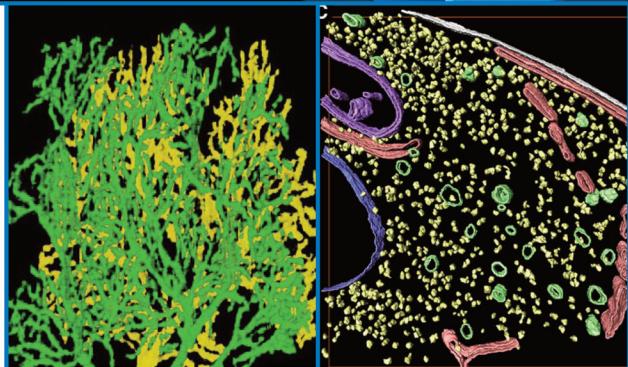
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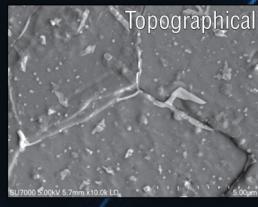
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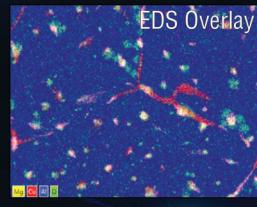
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